

# UNOFFICIAL COPY



Doc#: 0715506022 Fee: \$26.50  
Eugene "Gene" Moore RHSP Fee: \$10.00  
Cook County Recorder of Deeds  
Date: 06/04/2007 08:39 AM Pg: 1 of 2

*PS*  
Prepared by: PURVI SHAH  
OCWEN LOAN SERVICING, LLC  
1661 Worthington Road Suite 100  
West Palm Beach, Florida 33409  
Loan Number: 30714350  
Investor #: 396

## ILLINOIS RELEASE OF MORTGAGE

In consideration of the payment and full satisfaction of the debt secured by the Mortgage dated APRIL 1, 1997 and executed by MARVIN COX AND VELVA COX, as Mortgagor(s), in the amount of \$44,000.00, and recorded on 4-23-97, in Book \_\_\_\_\_ at Page \_\_\_\_\_ as document number 92279222, in the Office of the Recorder of Deeds of COOK County, Illinois, the undersigned hereby releases said Mortgage which formally encumbered the described property:

### LEGAL DESCRIPTION:

*112H*  
LOT 41 IN BLOCK 5 IN B.F. JACOB'S SUBDIVISION OF THE EAST  
1/2 OF THE WEST 1/2 OF THE NORTHEAST 1/4 OF SECTION 30,  
TOWNSHIP 38 NORTH, RANGE 14, EAST OF THE THIRD PRINCIPAL  
MERIDIAN, (EXCEPT THE SOUTH 627 FEET THEREOF) IN COOK  
COUNTY, ILLINOIS.

Commonly known as: 7319 SOUTH HONORE STREET, CHICAGO, ILLINOIS

Tax ID #: 20302190070000

Dated: MAY 11, 2007

When Recorded Mail To:  
Financial Dimensions, Inc.  
1400 Lebanon Church Road  
Pittsburgh, PA 15236

*520871*

*S-Y  
P-2  
H-Y  
MR*

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Property of Cook County Office

**AMRESCO RESIDENTIAL MORTGAGE CORPORATION**





Name: Neil Dyson  
Title: Vice President

STATE OF FLORIDA }  
                                  } SS  
COUNTY OF PALM BEACH }

The foregoing instrument was acknowledged before me, the undersigned Notary, on MAY 11, 2007, by Neil Dyson, Vice President of **AMRESCO RESIDENTIAL MORTGAGE CORPORATION**, on behalf of the corporation. Neil Dyson is personally known to me.

Witness my Hand and Seal of Office.

  
Notary Public - State of Florida

NOTARY PUBLIC - STATE OF FLORIDA  
 Doris Chapman  
Commission # DC518204  
Expires: FEB. 14, 2010  
Bonded Thru Atlantic Bonding Co., Inc.